



Announcement

Acta Materialia and Scripta Materialia Outstanding Reviewers in 2022

Peer review is a cornerstone of science. Acta Materialia, Inc. is dedicated to supporting and recognizing the journals' reviewers. The Acta Journals are delighted to announce the recipients of the 2023 Outstanding Reviewer awards for excellence in reviewing throughout the calendar year of 2022. These awards are selected by the Editors of Acta Materialia, Scripta Materialia, Acta Biomaterialia and Materialia. Each recipient receives a certificate and is offered an honorarium as thanks for their support of the titles, as well as their help ensuring the continued high quality of the journals.

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